

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Title::	Chip scale package with flip chip interconnect
Attorney Docket Number::	CPAC 1008-2 US
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Rajendra
Family Name::	PENDSE
City of Residence::	Fremont
State or Province of Residence::	CA
Country of Residence::	US
Street of mailing address::	5245 Diamond Common
City of mailing address::	Fremont
State or Province of mailing address::	CA

Country of mailing address:: US
Postal or Zip Code of mailing address:: 94555

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Nazir
Family Name:: AHMAD
City of Residence:: San Jose
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 739 Seawood Way
City of mailing address:: San Jose
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95120

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Andrea
Family Name:: CHEN
City of Residence:: San Jose
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 6923 Chantel Court
City of mailing address:: San Jose
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95129

Applicant Authority Type:: Inventor
 Primary Citizenship Country:: Republic of Korea
 Status:: Full Capacity
 Given Name:: Kyung-Moon
 Family Name:: KIM
 City of Residence:: Ichon-si
 State or Province of Residence:: Kyoung ki-do
 Country of Residence:: Republic of Korea
 Street of mailing address:: 312-1 Sadong-ri, Daeyeul-myun
 Samjin Apt., 1-301
 City of mailing address:: Ichon-si
 State or Province of mailing address:: Kyoung ki-do
 Country of mailing address:: Republic of Korea
 Postal or Zip Code of mailing address:: 467-850

Applicant Authority Type:: Inventor
 Primary Citizenship Country:: US
 Status:: Full Capacity
 Given Name:: Young-Do
 Family Name:: KWEON
 City of Residence:: Cupertino
 State or Province of Residence:: CA
 Country of Residence:: US
 Street of mailing address:: 20200 Lucille Avenue, #111
 City of mailing address:: Cupertino
 State or Province of mailing address:: CA
 Country of mailing address:: US
 Postal or Zip Code of mailing address:: 95014

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Samuel
Family Name:: TAM
City of Residence:: Daly City
State or Province of Residence:: CA
Country of Residence:: US
Street of mailing address:: 102 Ashland Drive
City of mailing address:: Daly City
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 94015

Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Non-Provisional of	60/272,237	02/27/01

Assignee Information

Assignee name:: ChipPAC, Inc.
Street of mailing address:: 47400 Kato Road
City of mailing address:: Fremont
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 94538

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